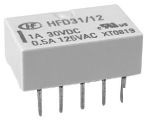
HFD31 SUBMINIATURE SIGNAL RELAY



c UL us
File No.:E133481

Features

- Offers excellent board space savings
- Surge withstand voltage up to 1500V, meets FCC Part 68
- High contact capacity 2A 30VDC
- Low power consumption
- Single side stable and latching type available
- Single or double coil winding type available

RoHS compliant

CONTACT DATA

Contact arrangement	2C
Contact resistance	100mΩ max. (at 10mA 30mVDC)
Contact material	AgPd + Au plated, AgNi + Au plated
Contact rating (Res. load)	1A 30VDC 2A 30VDC 0.5A 125VAC
Max. switching current	2A
Max. switching voltage	250VAC/220VDC
Max. switching power	62.5VA / 30W
Min. applicable load 1)	10mV 10μA
Mechanical endurance	1 x 10^8OPS
Electrical endurance 2)	1 x 10^5OPS (0.5A 125VAC, Resistive load, AgNi + Au plated, at 70˚C, 1s on 9s off)

Notes: 1) Min. applicable load is reference value. Please perform the confirmation test with the actual load before production since reference value may change according to switching frequencies, environmental conditions and expected contact resistance and reliability.
2) Electrical endurance test is conducted with load being connected to NO or NC contacts.

COIL

Coil power	Single side stable	Approx. 140mW (24VDC: Approx. 200mW)
	1 coil latching	Approx.100mW (24VDC: Approx.150mW)
	2 coils latching	Approx. 200mW (24VDC:Approx. 300mW)

CHARACTERISTICS

Insulation resistance		1000MΩ (at 500VDC)
Dielectric strength	Between coil & contacts	1500VAC 1min
	Between open contacts	750VAC 1min
	Between contact sets	1500VAC 1min
Surge withstand voltage Between open contacts (10/160μs)		1500VAC (FCC part 68)
Operate time (Set time)		3ms max.
Release time (Reset time)		3ms max.
Ambient temperature		-40˚C to 70˚C
Humidity		5% to 85% RH
Vibration resistance		10Hz to 55Hz 3.0mm DA
Shock resistance	Functional	735m/s^2
	Destructive	980m/s^2
Termination		DIP, SMT
Unit weight		Approx. 1.8g
Moisture sensitivity levels (Only for SMT type, JEDEC-STD-020)		MSL-3
Construction		Plastic sealed

Notes: 1) The data shown above are initial values.
2) UL insulation system: Class A

SAFETY APPROVAL RATINGS

UL/CUL	AgNi + Au plated	1A 30VDC (70˚C) 2A 30VDC (40˚C) 0.5A 125VAC (70˚C)

Notes: 1) All values unspecified are at room temperature.
2) Only typical loads are listed above. Other load specifications

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COIL DATA

at 23°C

Single side stable

Coil Code	Nominal Voltage VDC	Pick-up Voltage VDC max.	Drop-out Voltage VDC min.	Coil Resistance Ω	Nominal Power mW approx.	Max. Voltage VDC
HFD31/1.5	1.5	1.13	0.15	16 x (1±10%)	140	2.25
HFD31/2.4	2.4	1.8	0.24	41.3 x (1±10%)	140	3.6
HFD31/3	3	2.25	0.3	64.3 x (1±10%)	140	4.5
HFD31/4.5	4.5	3.38	0.45	145 x (1±10%)	140	6.7
HFD31/5	5	3.75	0.5	178 x (1±10%)	140	7.5
HFD31/6	6	4.5	0.6	257 x (1±10%)	140	9
HFD31/9	9	6.75	0.9	579 x (1±10%)	140	13.5
HFD31/12	12	9	1.2	1028 x (1±10%)	140	18
HFD31/24	24	18	2.4	2880 x (1±10%)	200	36

1 coil latching

Coil Code	Nominal Voltage VDC	Set Voltage VDC max.	Reset Voltage VDC max.	Coil Resistance Ω	Nominal Power mW approx.	Max. Voltage VDC
HFD31/1.5-L1	1.5	1.13	1.13	22.5 x (1±10%)	100	2.25
HFD31/2.4-L1	2.4	1.8	1.8	58 x (1±10%)	100	3.6
HFD31/3-L1	3	2.25	2.25	90 x (1±10%)	100	4.5
HFD31/4.5-L1	4.5	3.38	3.38	203 x (1±10%)	100	6.7
HFD31/5-L1	5	3.75	3.75	250 x (1±10%)	100	7.5
HFD31/6-L1	6	4.5	4.5	360 x (1±10%)	100	9
HFD31/9-L1	9	6.75	6.75	810 x (1±10%)	100	13.5
HFD31/12-L1	12	9	9	1440 x (1±10%)	100	18
HFD31/24-L1	24	18	18	3840 x (1±10%)	150	36

2 coils latching

Coil Code	Nominal Voltage VDC	Set Voltage VDC max.	Reset Voltage VDC max.	Coil Resistance Ω	Nominal Power mW approx.	Max. Voltage VDC
HFD31/1.5-L2	1.5	1.13	1.13	11.3 x (1±10%)	200	2.25
HFD31/2.4-L2	2.4	1.8	1.8	29 x (1±10%)	200	3.6
HFD31/3-L2	3	2.25	2.25	45 x (1±10%)	200	4.5
HFD31/4.5-L2	4.5	3.38	3.38	101 x (1±10%)	200	6.7
HFD31/5-L2	5	3.75	3.75	125 x (1±10%)	200	7.5
HFD31/6-L2	6	4.5	4.5	180 x (1±10%)	200	9.0
HFD31/9-L2	9	6.75	6.75	405 x (1±10%)	200	13.5
HFD31/12-L2	12	9	9	720 x (1±10%)	200	18
HFD31/24-L2	24	18	18	1920 x (1±10%)	300	36

Notes: 1) When user's requirements can't be found in the above table,special order allowed.
2) In case 5V of transistor drive circuit, it is recommended to use 4.5V type relay, and 3V to use 2.4V type relay.

ORDERING INFORMATION

	HFD31 /	24	-L1	4	S	R	(XXX)
Type							
Coil voltage	1.5, 2.4, 3, 4.5, 5, 6, 9, 12, 24VDC						
Sort	**L1:** 1 coil latching **L2:** 2 coils latching **Nil:** Single side stable						
Contact material	**4:** AgPd+Gold plated **Nil:** AgNi+Gold plated						
Terminal type	**S:** Standard SMT **S1:** Short terminal SMT **Nil:** DIP						
Packing style	**R:** Tape and reel packing (Only for SMT type)[1] **Nil:** Tube packing(Only for DIP type)						
Special code[2]	**XXX:** Customer special requirement **Nil:** Standard						

Notes: 1) R type (tape and reel) packing is moisture-proof which meets requirement of MSL-3. Please choose R type packing for SMT products. For R type, the letter "R" will only be printed on packing tag but not on relay cover. Tube packing is normally not available for SMT products unless specially requested by customer. But please note that tube packing is not moisture-proof so please bake the products before use according to description of Notice 11 herewith. In addition, tube packaging will be adopted when the ordering quantity of R type is equal to or less than 100 pieces unless otherwise specified.
2) The customer special requirement express as special code after evaluating by Hongfa.
3) Standard tube packing length is 580mm. Any special requirement needed, please contact us for more details.
4) For products that should meet the explosion-proof requirements of "IEC 60079 series",please note [Ex] after the specification while placing orders.Not all products have explosion-proof certification,so please contact us if necessary, in order to select the suitable products.

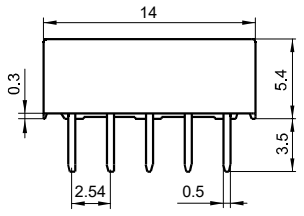
OUTLINE DIMENSIONS, WIRING DIAGRAM AND PC BOARD LAYOUT

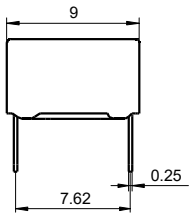
Unit: mm

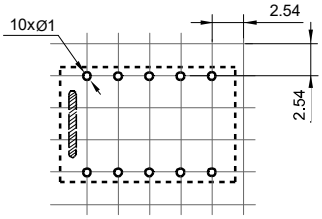
Outline Dimensions

PCB Layout
(Bottom view)

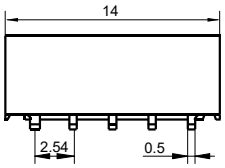
DIP type

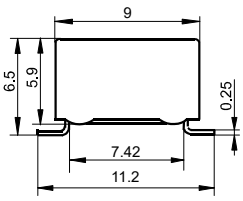


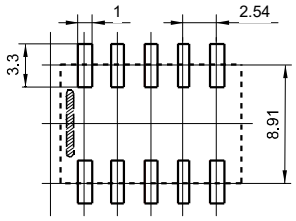




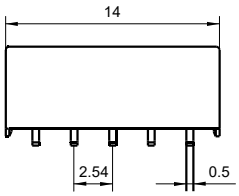
Standard
SMT type

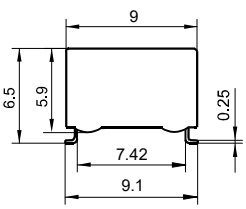


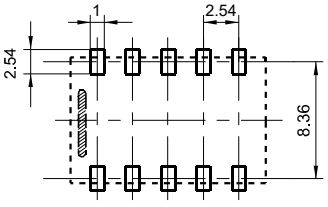




Short terminal SMT
(S1 type)







Remark: 1) The pin dimension of the product outline drawing is the size before tinning (it will become larger after tinning), and the mounting hole size is the recommended design size of the PCB board hole. The specific PCB board hole design size can be mapped and adjusted according to the actual product.
2) In case of no tolerance shown in outline dimension: outline dimension ≤1mm, tolerance should be ±0.2mm; outline dimension >1mm and ≤5mm, tolerance should be ±0.3mm; outline dimension >5mm, tolerance should be ±0.4mm.
3) The tolerance without indicating for PCB layout is always ±0.1mm.

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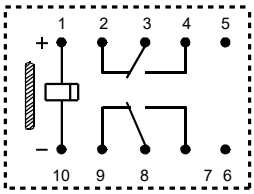
OUTLINE DIMENSIONS, WIRING DIAGRAM AND PC BOARD LAYOUT

Unit: mm

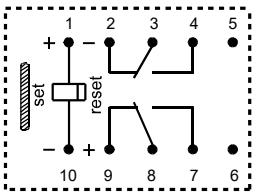
Wiring Diagram
(Bottom view)

Single side stable



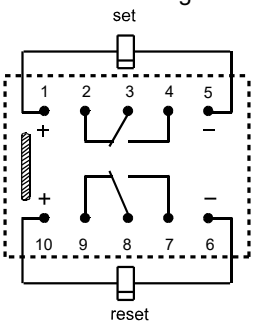
Deenergized condition

1 coil latching



Reset condition

2 coils latching

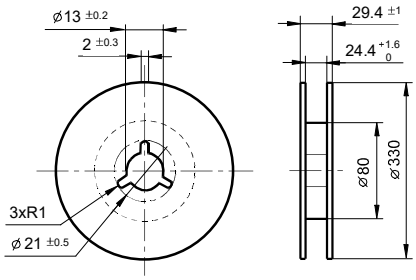


Reset condition

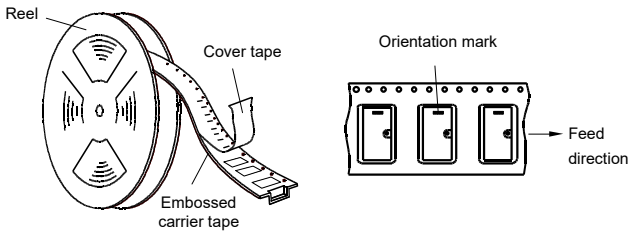
TAPE & REEL PACKING CONSTRUCTION AND DIMENSION

Unit: mm

Reel Dimensions

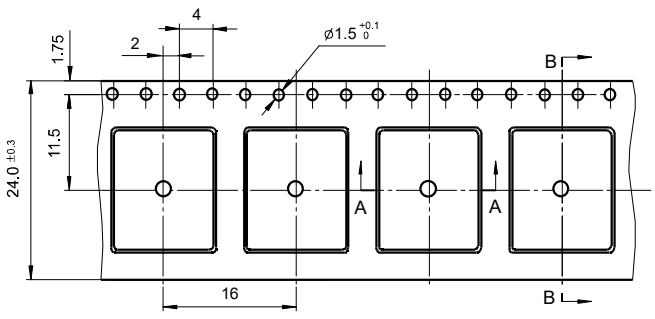


Direction of Relay Insertion

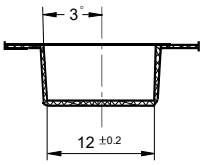


Notes: 1) Packing: 550pcs/reel, 4 reels/carton.
2) MOQ for reel packing is 550pcs.

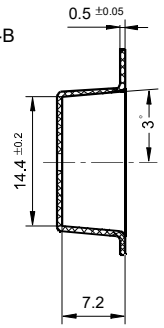
Tape Dimensions (S type:Standard SMT type)



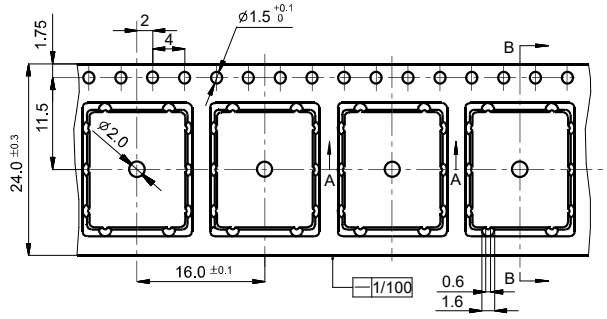
A-A



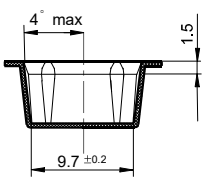
B-B



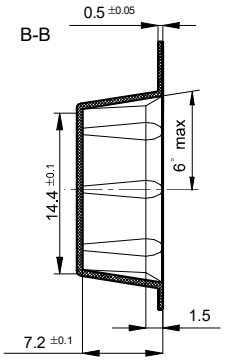
Tape Dimensions (Short terminal SMT)



A-A



B-B



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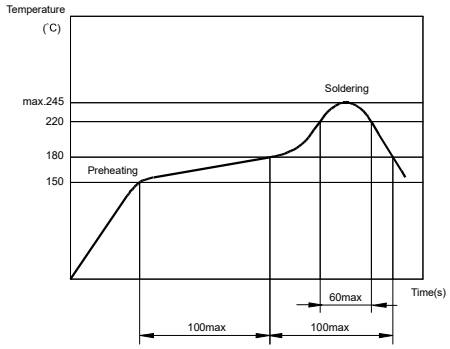
RECOMMENDED SOLDERING CONDITIONS

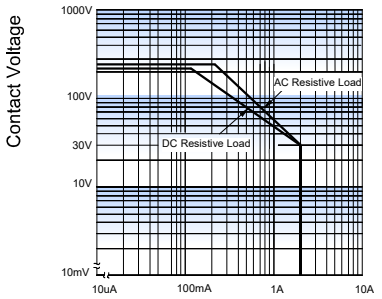
Temperature/Time profile of Reflow Soldering see below:



Notes: 1) Temperature profile shows Printed Circuit Board surface temperature on the relay terminal portion.
2) Please check the actual soldering condition to use other method except above mentioned temperature profiles.

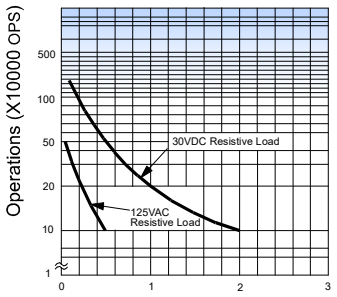
CHARACTERISTIC CURVES

MAXIMUM SWITCHING POWER



Contact Current

ENDURANCE CURVE



Contact Current (A)

Test conditions:
Resistive load, at 40°C, 1s on 9s off.

Notice

1) This relay is highly sensitive polarized relay, if correct polarity is not applied to the coil terminals, the relay does not operate properly.
2) To avoid using relays under strong magnetic field which will change the parameters of relays such as pick-up voltage and drop-out voltage.
3) Relay is on the “reset” status when being released from stock, with the consideration of shock risen from transit and relay mounting, it should be changed to the “set” status when application(connecting to the power supply). Please reset the relay to “set” or “reset” status on request.
4) Energizing coil with rated voltage is basic for normal operation of a relay, please make sure the energized voltage to relay coil have reached the rated voltage. Regarding latching relay, in order to maintain the "set" or "reset" status, impulse width of the rated voltage applied to coil should be more than 5 times of "set" or "reset" time.
5) For 2 coil latching relay, do not energize voltage to “set” coil and “reset” coil simultaneously.
6) The relay may be damaged because of falling or when shocking conditions exceed the requirement.
7) For SMT products, validation with real application should be done before your series production, if the reflow-soldering temperature curve is out of our recommendation. Generally, two-time reflow-soldering is not recommended for the relay. However, if two-time reflow-soldering is required, a 60-min. interval should be guaranteed and a validation should be done before production.
8) Contact is recommended for suitable condition and specifications if water cleaning or surface process is involved in assembling relays on PCB.
9) Regarding the plastic sealed relay, we should leave it cooling naturally untill below 40°C after welding, then clean it and deal with coating, remarkably the temperature of solvents should also be controlled below 40°C.Please avoid cleaning the relay by ultrasonic, avoid using the solvents like gasoline, Freon, and so on, which would affect the configuration of relay or influence the environment.
10) About preferable condition of operation, storage and transportation, please refer to "Explanation to terminology and guidetines of relay".
11) Relays packaged in moisture barrier bags meet MSL-3 requirements. The relays should be stored at ambient conditions of ⩽30°C and ⩽60% RH after they are removed from their packaging, and should be used within 168 hours. If the relays cannot be used within 168 hours, please repack them or store them in a drying oven at 25°C±5°C, ⩽10% RH. Otherwise, relays may be subjected to a soldering test to check their performance, or they may be used after keeping them in an oven for 72 hours at with 50°C±5°C, ⩽30% RH.

Disclaimer

The specification is for reference only. See to "Terminology and Guidelines" for more information. Specifications subject to change without notice. We could not evaluate all the performance and all the parameters for every possible application. Thus the user should be in a right position to choose the suitable product for their own application. If there is any query, please contact Hongfa for the technical service. However, it is the user’s responsibility to determine which product should be used only.